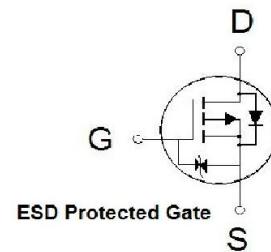


**NIKO-SEM****P-Channel Logic Level Enhancement Mode  
Field Effect Transistor****PV5G3EA  
SOP-8  
Halogen-free & Lead-Free****PRODUCT SUMMARY**

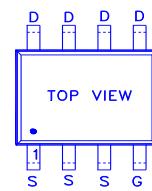
$V_{(BR)DSS}$	$R_{DS(ON)}$	$I_D$
-30V	8mΩ	-15A

**Features**

- Pb-Free, Halogen Free and RoHS compliant.
- Low  $R_{DS(on)}$  to Minimize Conduction Losses.
- Ohmic Region Good  $R_{DS(on)}$  Ratio.
- Optimized Gate Charge to Minimize Switching Losses.
- Products Integrated ESD diode with ESD Protected.

**Applications**

- Protection Circuits Applications.
- Logic/Load Switch Circuits Applications.



G : GATE  
D : DRAIN  
S : SOURCE

100% UIS Tested  
100% Rg Tested

**ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$  Unless Otherwise Noted)**

PARAMETERS/TEST CONDITIONS	SYMBOL	LIMITS	UNITS
Drain-Source Voltage	$V_{DS}$	-30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$I_D$	-15	A
		-12	
Pulsed Drain Current <sup>1</sup>	$I_{DM}$	-60	
Avalanche Current	$I_{AS}$	-67	
Avalanche Energy	$E_{AS}$	224	mJ
Power Dissipation <sup>3</sup>	$P_D$	2.9	W
		1.8	
Junction & Storage Temperature Range	$T_j, T_{stg}$	-55 to 150	°C

**THERMAL RESISTANCE RATINGS**

THERMAL RESISTANCE		SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient <sup>2</sup>	$t \leq 10\text{s}$	$R_{\theta JA}$	°C / W	43	°C / W
Junction-to-Ambient <sup>2</sup>	Steady-State	$R_{\theta JA}$		62	
Junction-to-Case	Steady-State	$R_{\theta JC}$		20	

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ .

<sup>3</sup>The Power dissipation is based on  $R_{\theta JA} t \leq 10\text{s}$  value.

**NIKO-SEM****P-Channel Logic Level Enhancement Mode  
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SOP-8  
Halogen-free & Lead-Free****ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ , Unless Otherwise Noted)**

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-30			V
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	-1.3	-1.75	-2.3	
Gate-Body Leakage	$I_{\text{GSS}}$	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 20\text{V}$			$\pm 10$	$\mu\text{A}$
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = -30\text{V}, V_{\text{GS}} = 0\text{V}$			-1	$\mu\text{A}$
		$V_{\text{DS}} = -30\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 55^\circ\text{C}$			-10	
Drain-Source On-State Resistance <sup>1</sup>	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}} = -4.5\text{V}, I_D = -10\text{A}$		8.6	13.8	$\text{m}\Omega$
		$V_{\text{GS}} = -10\text{V}, I_D = -15\text{A}$		5.5	8	
Forward Transconductance <sup>1</sup>	$g_{\text{fs}}$	$V_{\text{DS}} = -5\text{V}, I_D = -15\text{A}$		52		S

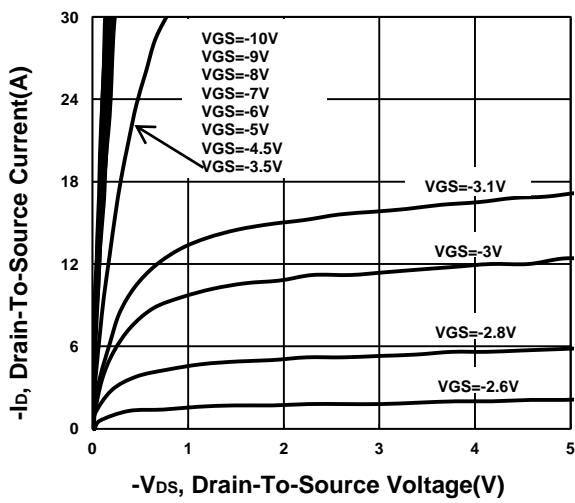
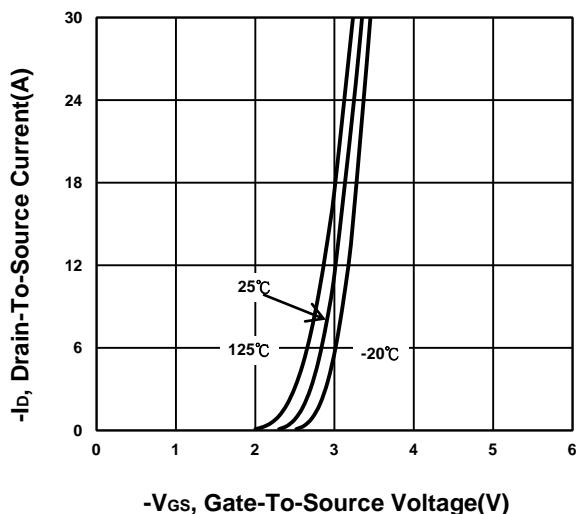
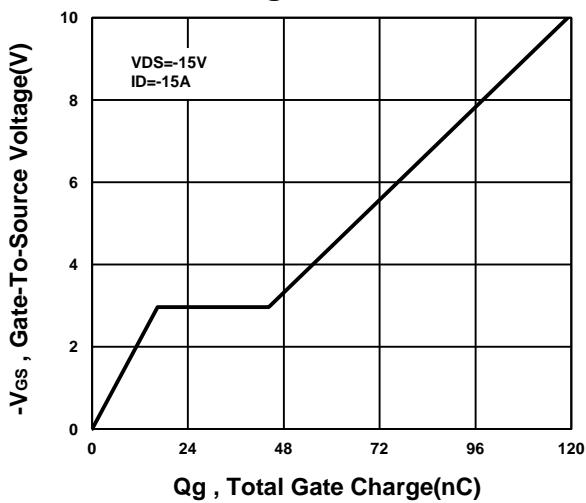
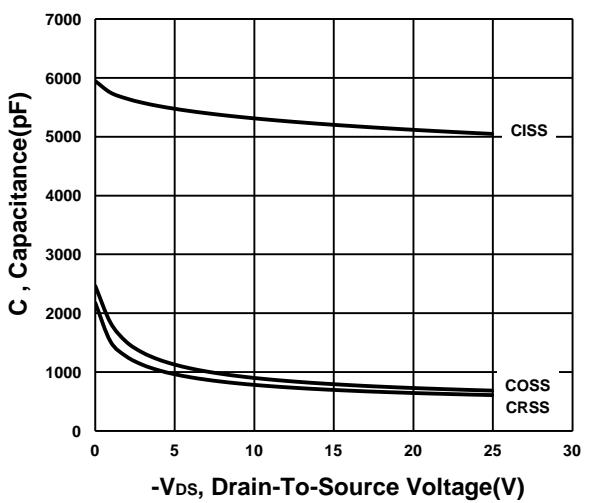
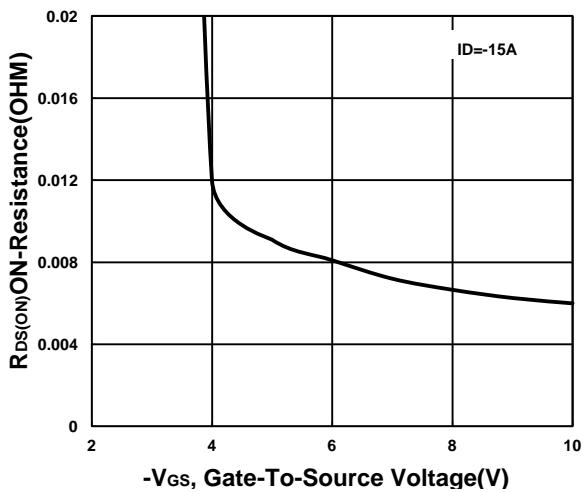
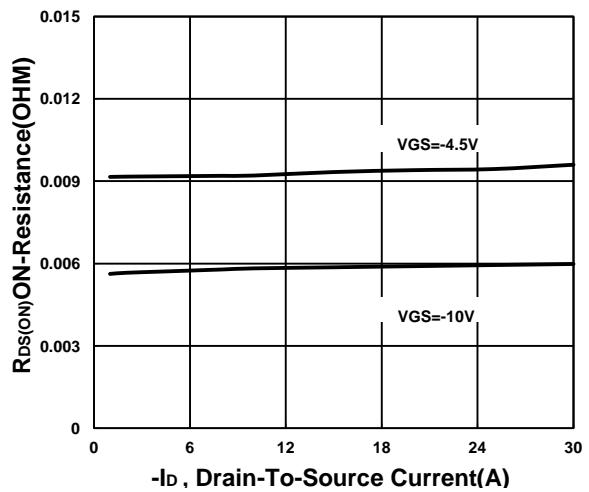
**DYNAMIC**

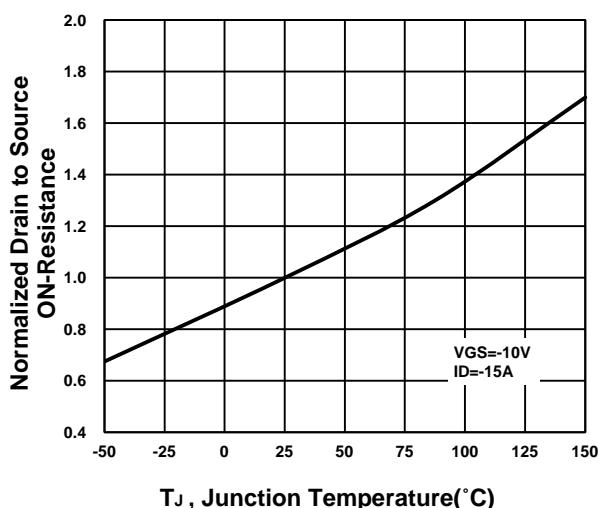
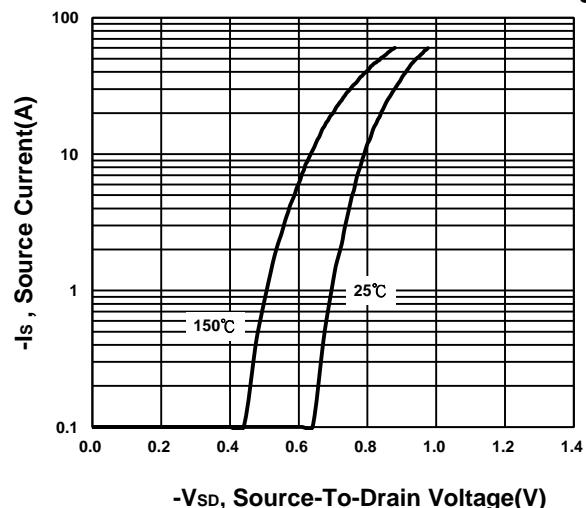
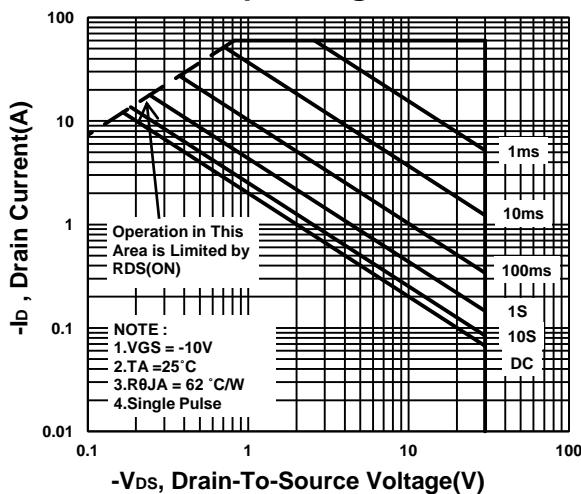
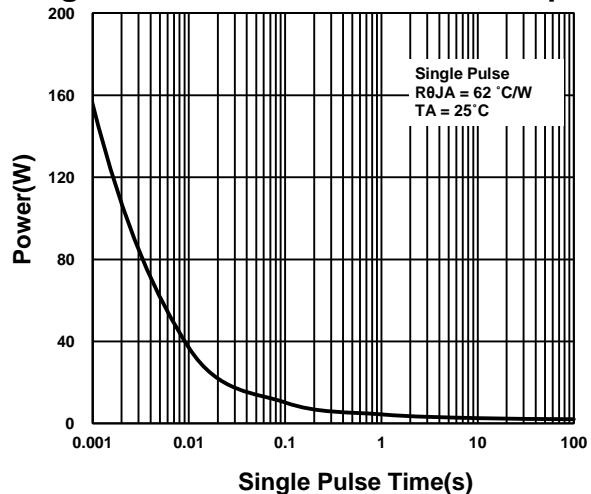
Input Capacitance	$C_{\text{iss}}$	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = -15\text{V}, f = 1\text{MHz}$	5270		pF
Output Capacitance	$C_{\text{oss}}$		796		
Reverse Transfer Capacitance	$C_{\text{rss}}$		702		
Gate Resistance	$R_g$	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 0\text{V}, f = 1\text{MHz}$	1.9		$\Omega$
Total Gate Charge <sup>2</sup>	$Q_g$	$V_{\text{DS}} = -15\text{V}, V_{\text{GS}} = -10\text{V}, I_D = -15\text{A}$	119		nC
Gate-Source Charge <sup>2</sup>	$Q_{\text{gs}}$		16.4		
Gate-Drain Charge <sup>2</sup>	$Q_{\text{gd}}$		27.8		
Turn-On Delay Time <sup>2</sup>	$t_{\text{d}(\text{on})}$		24		
Rise Time <sup>2</sup>	$t_r$	$V_{\text{DD}} = -15\text{V}$ $I_D \approx -15\text{A}, V_{\text{GS}} = -10\text{V}, R_{\text{GEN}} = 6\Omega$	88		nS
Turn-Off Delay Time <sup>2</sup>	$t_{\text{d}(\text{off})}$		154		
Fall Time <sup>2</sup>	$t_f$		121		

**SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ )**

Continuous Current	$I_S$				-2.4	A
Forward Voltage <sup>1</sup>	$V_{\text{SD}}$	$I_F = -15\text{A}, V_{\text{GS}} = 0\text{V}$			-1.2	V
Reverse Recovery Time	$t_{\text{rr}}$	$I_F = -15\text{A}, dI/dt = 100\text{A}/\mu\text{s}$		27		nS
Reverse Recovery Charge	$Q_{\text{rr}}$			22		nC

<sup>1</sup>Pulse test : Pulse Width  $\leq 300\ \mu\text{sec}$ , Duty Cycle  $\leq 2\%$ .<sup>2</sup>Independent of operating temperature.

**NIKO-SEM****P-Channel Logic Level Enhancement Mode  
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SOP-8  
Halogen-free & Lead-Free****Output Characteristics****Transfer Characteristics****Gate charge Characteristics****Capacitance Characteristic****On-Resistance VS Gate-To-Source Voltage****On-Resistance VS Drain Current**

**NIKO-SEM****P-Channel Logic Level Enhancement Mode  
Field Effect Transistor****PV5G3EA  
SOP-8  
Halogen-free & Lead-Free****On-Resistance VS Temperature****Source-Drain Diode Forward Voltage****Safe Operating Area****Single Pulse Maximum Power Dissipation****Transient Thermal Response Curve**